

4V Drive Pch+Pch MOSFET

SH8J65

Structure

Silicon P-channel MOSFET

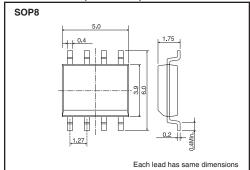
● Features

- 1) Low On-resistance.
- 2) Built-in G-S Protection Diode.
- 3) Small Surface Mount Package (SOP8).

Application

Switching

●Dimensions (Unit : mm)



Packaging specifications

	Package	Taping
Type	Code	TB
	Basic ordering unit (pieces)	2500
SH8J65		0

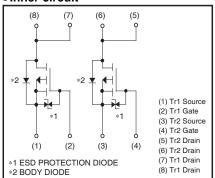
●Absolute maximum ratings (Ta=25°C)

<It is the same ratings for the Tr1 and Tr2.>

Parameter		Symbo	ı	Limits	Unit
Drain-source voltage		VDSS		-30	V
Gate-source voltage		V _{GSS}		±20	V
Drain current	Continuous	ID		±7.0	Α
Drain current	Pulsed	I_{DP}	*1	±28	Α
Source current	Continuous	Is		-1.6	Α
(Body diode)	Pulsed	I _{SP}	*1	-28	Α
Total power dissipation		Pp	*2	2.0	W / TOTAL
		10		1.4	W / ELEMENT
Channel temperature		Tch		150	°C
Range of Storage temperature		Tstg		-55 to +150	°C

^{*1} Pw≤10μs, Duty cycle≤1% *2 Mounted on a ceramic board

●Inner circuit



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●Electrical characteristics (Ta=25°C) <It is the same characteristics for the Tr1 and Tr2.>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions	
Gate-source leakage	Igss	_	-	±10	μΑ	V _{GS} =±20V, V _{DS} =0V	
Drain-source breakdown voltage	V _(BR) DSS	-30	_	_	V	I _D = -1mA, V _{GS} =0V	
Zero gate voltage drain current	IDSS	_	_	-1	μА	Vps= -30V, Vgs=0V	
Gate threshold voltage	V _{GS (th)}	-1.0	-	-2.5	V	V _{DS} = -10V, I _D = -1mA	
Static drain-source on-state resistance	R _{DS (on)} *	_	21.5	29.0	mΩ	I _D = -7A, V _G S= -10V	
		-	29.0	39.0	mΩ	I _D = -3.5A, V _G S= -4.5V *	
		_	31.0	40.8	mΩ	Ip= -3.5A, Vgs= -4.0V *	
Forward transfer admittance	Y _{fs} *	6.0	_	_	S	V _{DS} = -10V, I _D = -7A *	
Input capacitance	Ciss	-	1200	_	pF	V _{DS} = -10V	
Output capacitance	Coss	-	170	_	pF	V _{GS} =0V	
Reverse transfer capacitance	Crss	_	170	-	pF	f=1MHz	
Turn-on delay time	t _{d (on)} *	_	12	-	ns	Vpp≒ –15V	
Rise time	tr *	-	40	_	ns	ID= -3.5A	
Turn-off delay time	t _{d (off)} *	-	80	_	ns	V _{GS} = -10V R _L =4.3Ω	
Fall time	t _f *	_	65	-	ns	R _G =10Ω	
Total gate charge	Qg *	_	18	_	nC	V _{DD} ≒15V	
Gate-source charge	Q _{gs} *	_	3.5	-	nC	I _D = -7A V _G s= -5V	
Gate-drain charge	Q _{gd} *	_	6.5	_	nC	$R_L=2.1\Omega/R_G=10\Omega$	

^{*}Pulsed

●Body diode characteristics (Source-Drain) (Ta=25°C)

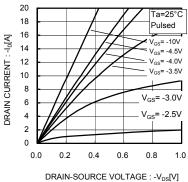
<It is the same characteristics for the Tr1 and Tr2.>

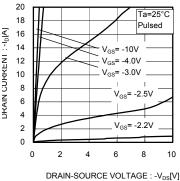
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	Vsp*	_	_	-1.2	V	Is= -7A, Vgs=0V

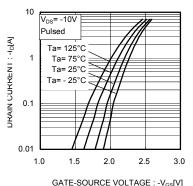
^{*}Pulsed

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•Electrical characteristic curves



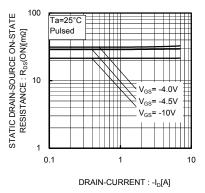




DRAIN-SOURCE VOLTAGE : -V_{DS}[V] Fig.1 Typical Output Characteristics(I)

DRAIN-SOURCE VOLTAGE : -V_{DS}[V]
Fig.2 Typical Output Characteristics(II)

Fig.3 Typical Transfer Characteristics



100 V_{GS}= -10V Pulsed Ta=125°C ON-SIANE SOURCE SOURCE ON-SIANE SOURCE SOURCE ON-SIANE SOURCE SOURCE SOURCE SOURCE SOURCE SOURCE SOURCE SOURCE

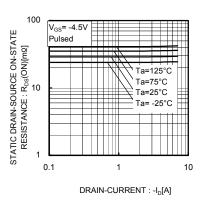
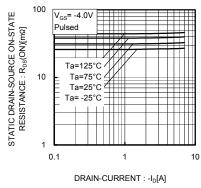
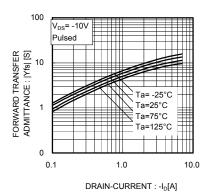


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current(I)

Fig.5 Static Drain-Source On-State Resistance vs. Drain Current(II)

Fig.6 Static Drain-Source On-State
Resistance vs. Drain Current(Ⅲ)





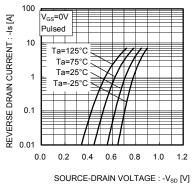
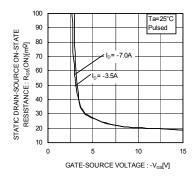


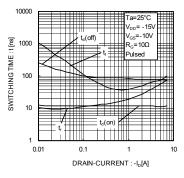
Fig.7 Static Drain-Source On-State
Resistance vs. Drain Current(IV)

Fig.8 Forward Transfer Admittance vs. Drain Current

Fig.9 Reverse Drain Current vs. Sourse-Drain Voltage

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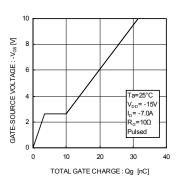
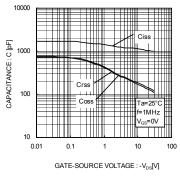


Fig.10 Static Drain-Source On-State

Resistance vs. Gate Source Voltage

Fig.11 Switching Characteristics

Fig.12 Dynamic Input Characteristics



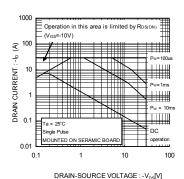


Fig.13 Typical Capacitance vs. Drain-Source Voltage

Fig.14 Maximum Safe Operating Aera

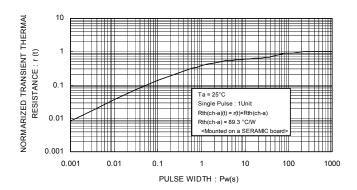


Fig.15 Normalized Transient Thermal Resistance vs. Pulse Width

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Measurement circuits

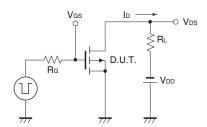


Fig.16 Switching Time Test Circuit

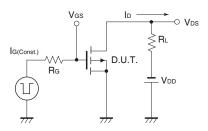


Fig.18 Gate Charge Test Circuit

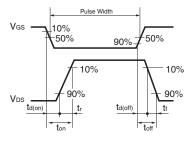


Fig.17 Switching Time Waveforms

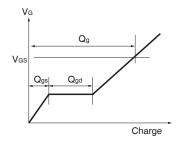


Fig.19 Gate Charge Waveform

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